505546266 06/26/2019

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
GURUVAYURAPPAN S. MATHUR	06/26/2019
ABBAS ALI	06/17/2019
POORNIKA FERNANDES	06/17/2019
SRINIVASAN BHASKAR	06/21/2019

RECEIVING PARTY DATA

Name:	TEXAS INSTRUMENTS INCORPORATED	
Street Address:	ress: 12500 TI BOULEVARD	
Internal Address:	M/S 3999	
City:	DALLAS	
State/Country:	TEXAS	
Postal Code:	75243	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16453796

CORRESPONDENCE DATA

Fax Number: (214)567-2228

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 214-479-7845 **Email:** uspto@ti.com

Correspondent Name: TEXAS INSTRUMENTS INCORPORATED

Address Line 1: PO BOX 655474

Address Line 2: M/S 3999

Address Line 4: DALLAS, TEXAS 75265

ATTORNEY DOCKET NUMBER:	TI-79412
NAME OF SUBMITTER:	COLLEEN F. BROWN
SIGNATURE:	/Colleen F. Brown/
DATE SIGNED:	06/26/2019

Total Attachments: 4

PATENT REEL: 049600 FRAME: 0598 source=79412_ASSIGN#page1.tif source=79412_ASSIGN#page2.tif source=79412_ASSIGN#page3.tif source=79412_ASSIGN#page4.tif

> PATENT REEL: 049600 FRAME: 0599

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, M/S 3999, Dallas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon, as well as to U.S. Provisional Application No. __________, filed ________.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby self and assign unto the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application(s) and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Patent and Trademark Office to issue all patents for said invention, or patents resulting therefrom, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful caths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I authorize the later insertion of the nonprovisional application number and filing date hereinbelow.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE	INTEGRATED CIRCUITS INCLUDING COMPOSITE DIELECTRIC LAYER 16/453,796 FILING DATE June 26, 2019		
NONPROVISIONAL APPLICATION NO.			June 26, 2019
SIGNATURE OF INVENTOR	Gringette -		
PRINTED NAME OF INVENTOR	Guruvayurappan S. MATHUR		
DATE	26 JUN 2019		
RESIDENCE (CITY AND STATE)	Plano, TX		

SIGNATURE OF INVENTOR	Warmen and the second s	
PRINTED NAME OF INVENTOR	Abbas ALI	
DATE	6.12-19	
RESIDENCE (CITY AND STATE)	Plano, TX	

RESIDENCE (CITY AND STATE)	Murphy, TX
DATE	
PRINTED NAME OF INVENTOR	Poomika FERNANDES
SIGNATURE OF INVENTOR	

SIGNATURE OF INVENTOR		
PRINTED NAME OF INVENTOR	Srinivasan BHASKAR	
DATE	Alien, TX	
RESIDENCE (CITY AND STATE)		

After recording, return Assignment to:

Texas Instruments incorporated PO Box 655474, M/S 3999 Dallas, Texas 75265

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REEL: 049600 FRAME: 0601

SIGNATURE OF INVENTOR		
PRINTED NAME OF INVENTOR	Abbas ALI	
DATE	winnin	
RESIDENCE (CITY AND STATE)	Plano, TX	

***************************************	SIGNATURE OF INVENTOR	
***************************************	PRINTED NAME OF INVENTOR	Poornika FERNANDES
***************************************	DATE	06/17/19
	RESIDENCE (CITY AND STATE)	Murphy, TX

	SIGNATURE OF INVENTOR		
	PRINTED NAME OF INVENTOR	Srinivasan BHASKAR	
	DATE		
***************************************	RESIDENCE (CITY AND STATE)	Allen, TX	

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SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Abbas ALI
DATE	
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SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Poornika FERNANDES
DATE	
RESIDENCE (CITY AND STATE)	Murphy, TX

SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Srinivasan BHASKAR
DATE	06/21/2019
RESIDENCE (CITY AND STATE)	Allen, TX

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